

THERMOREGULATED MICROVALVE FOR SELF-ADAPTIVE MICROFLUIDIC COOLING

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Stockholm, September 26th 2018

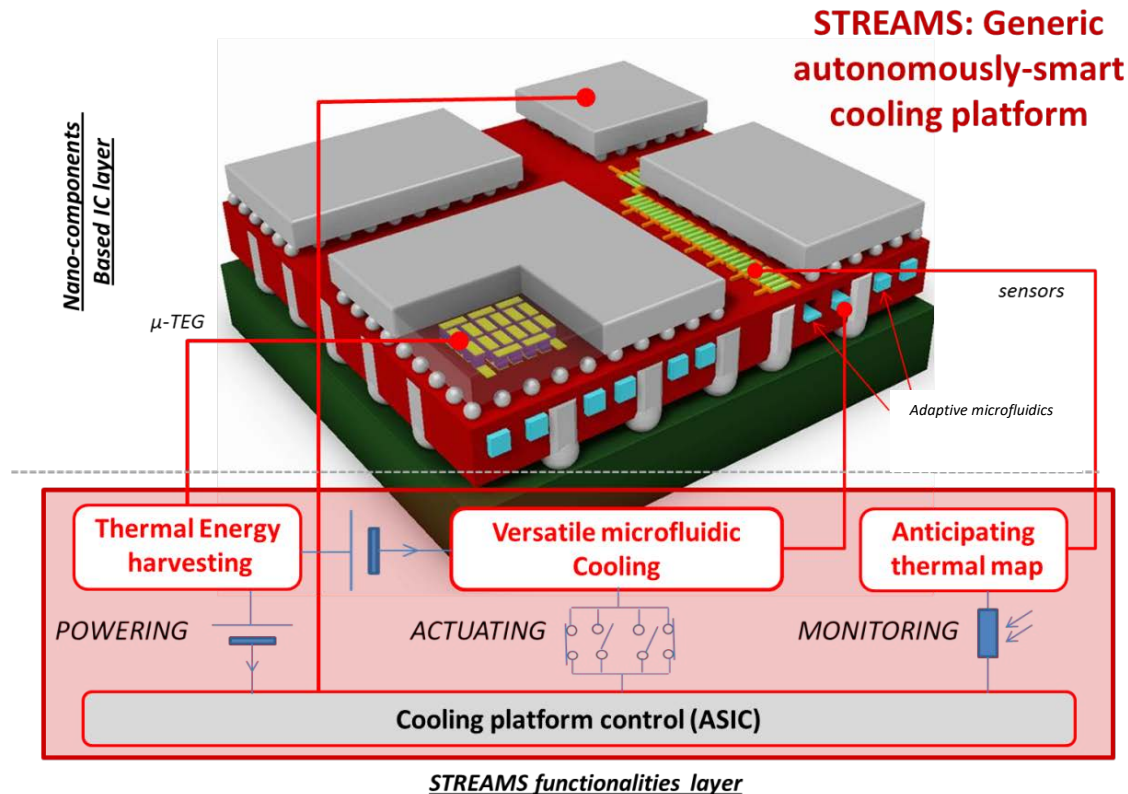
Outline

- Interest for liquid cooling
- Microvalves for Self-adaptive microfluidic cooling
 - Microfabrication process
 - Fluidic performances
- Conclusion

STREAMS European project

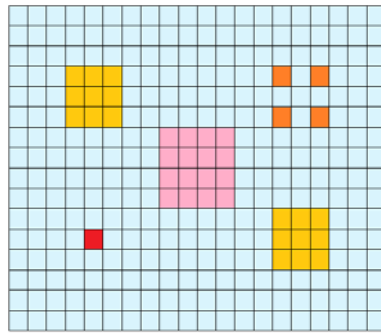
Intelligent thermal management in 3D

Approach: combine adaptive microfluidics with thermoelectric temperature mapping and energy harvesting into an interposer or 3D stack



Cell Array for distributed cooling

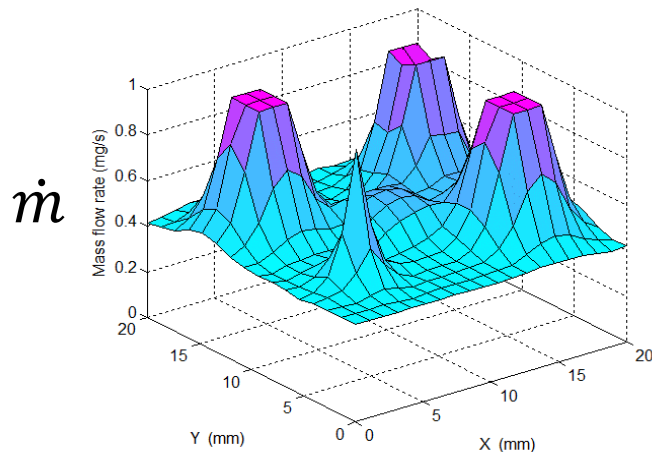
1. Discretize the interposer into cells



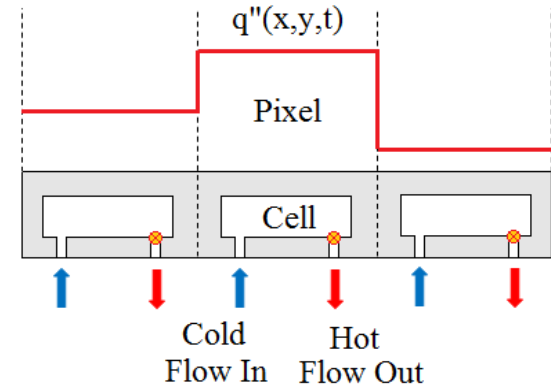
300 W/cm² 100 W/cm²
200 W/cm² 20 W/cm²

Thermal map

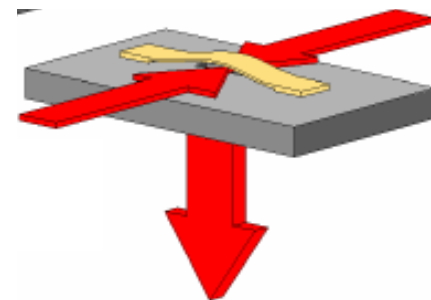
4. Tailored cooling for optimal cooling performance



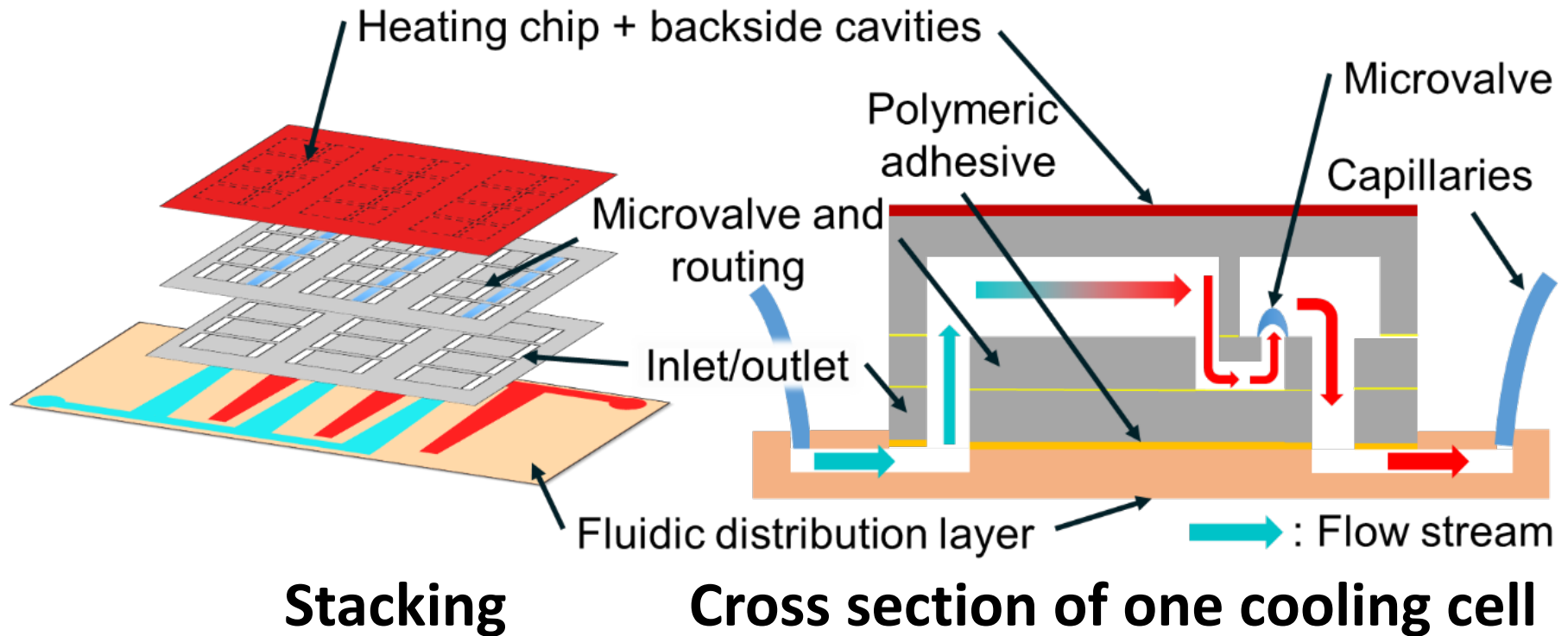
2. Each cell individually cooled (massive parallel configuration)



3. Valve controls coolant flow in each cell



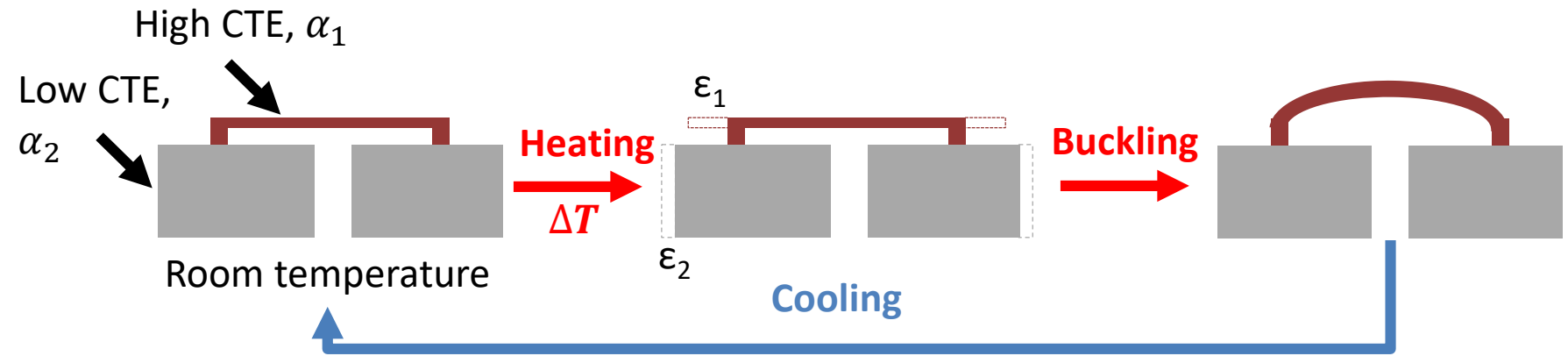
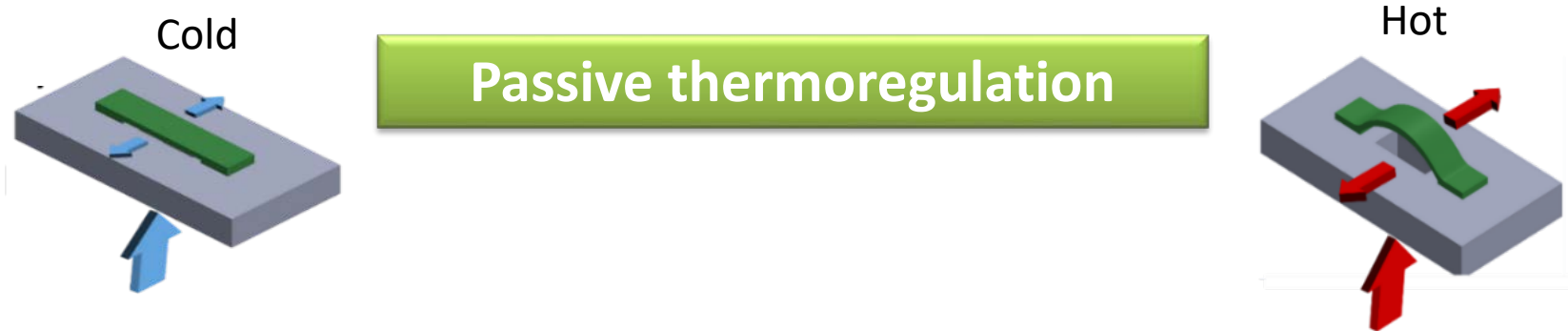
Microvalve integration



The microvalve is heated by the fluid locally:

- Sensing the temperature
- Actuated by heat

Thermoregulation principle of the microvalve

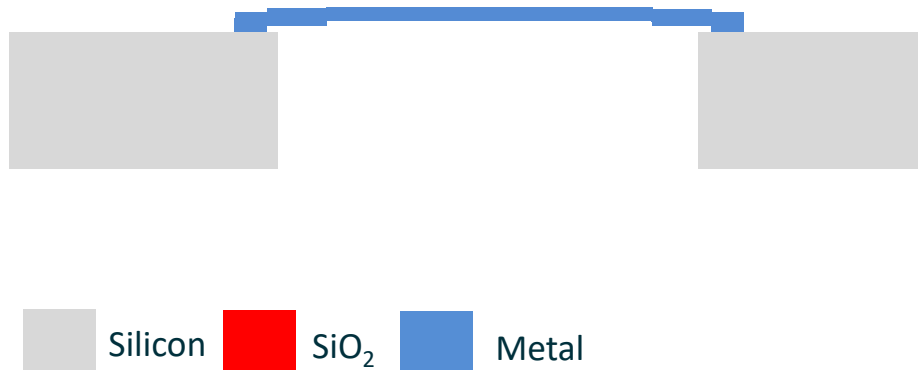


$$\begin{cases} \varepsilon_1 = \frac{\sigma_1}{E_1} = \alpha_1 \Delta T \\ \varepsilon_2 = \frac{\sigma_2}{E_2} = \alpha_2 \Delta T \end{cases} \Rightarrow \varepsilon_{tot} = \varepsilon_1 - \varepsilon_2 = (\alpha_1 - \alpha_2) \Delta T \Rightarrow \Delta T \uparrow \rightarrow \varepsilon_{tot} \uparrow \rightarrow \text{flow rate} \uparrow$$

For a fixed ΔT , high $\Delta\alpha$ gives large deformation

Fabrication of microvalves

Microfabrication process flow



Microfabrication techniques:

- Plasma enhanced chemical vapor deposition of SiO₂ (PECVD)
- Photolithography (4 photomasks) / Lift-off
- Reactive ion etching of SiO₂ (RIE)
- Metal deposition
- Deep reactive ion etching of Si

a) PECVD of 2 μm of SiO₂ on Si wafer

b) RIE of 0.7 μm of SiO₂ (eccentricities)

c) RIE of 1.3 μm of SiO₂ (anchors)

d) Deposition of 9 μm of metal and Lift-off

e) DRIE of 450 μm of Si (flow inlet)

f) Releasing by wet etching of SiO₂ with BOE

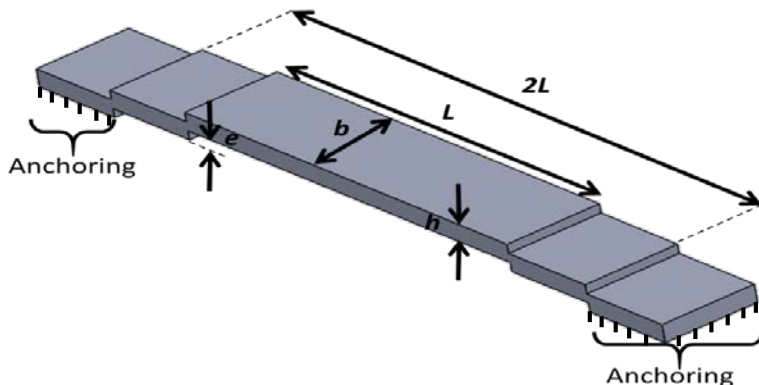
Design and material selection

Material selection based on

- ✓ Coefficient of thermal expansion compared to Si ($CTE_{Si} = 2.6 \mu m/^{\circ}C$)
- ✓ Simplicity of fabrication (PECVD deposition, electroplating, evaporation...)
- ✓ Mechanical properties and compatibility to water

Material	CTE ($\mu m/^{\circ}C$)	Sacrificial layer	Bonding at high temperature	Other
Ag	19	SiO_2	Yes	No residual stress (evaporation)
Au	14	SiO_2	Yes	Costing
Sn	22	Photoresist	No	Low fusion temperature
Ni	13	Photoresist	No	

Microvalve geometric variables

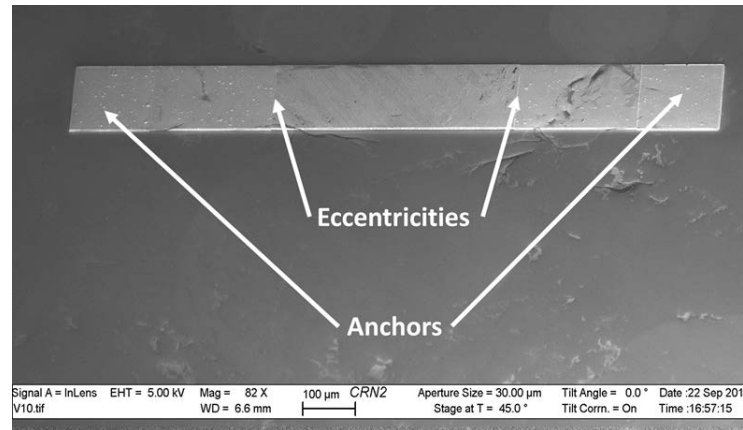


Valve design

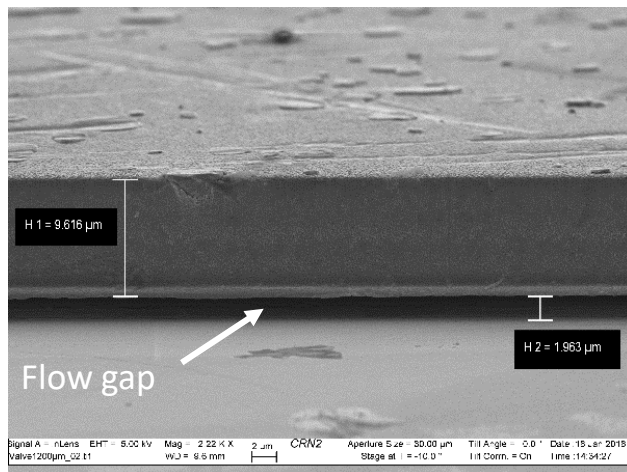
Valve	#1	#2
L	1733 μm	2000 μm
e	0.7 μm	0.7 μm
h	9 μm	9 μm
b	250 μm	250 μm

Fabrication of μ Valves

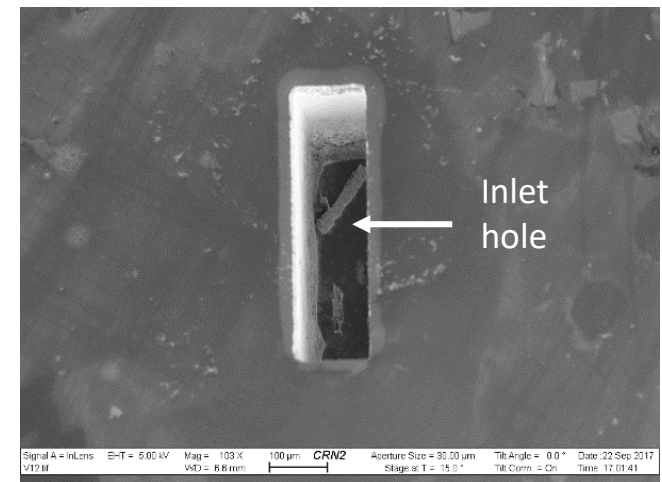
Scanning electron microscopy images of the released microvalve



Top view



Cross section view



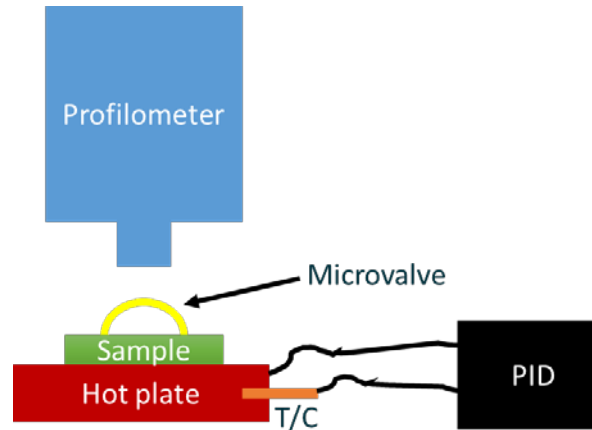
Bottom view

Process flow gave dimensions close to the one in the design phase

Experimental characterization

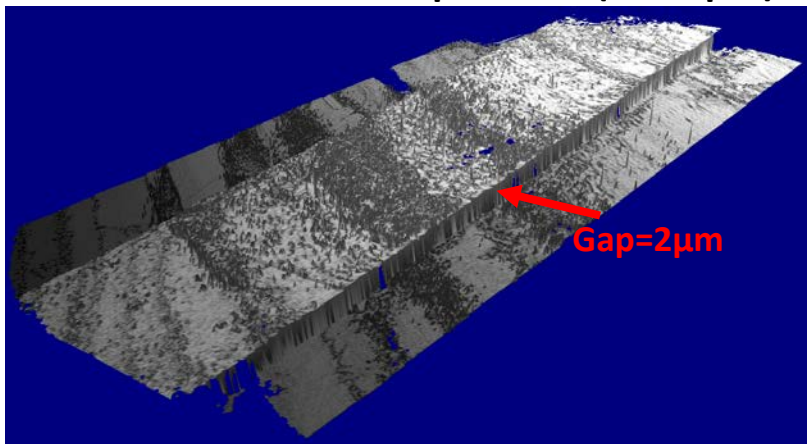
Optical profilometer characterization

- To measure the topology at room temperature
- To observe the geometry shift in function of the temperature

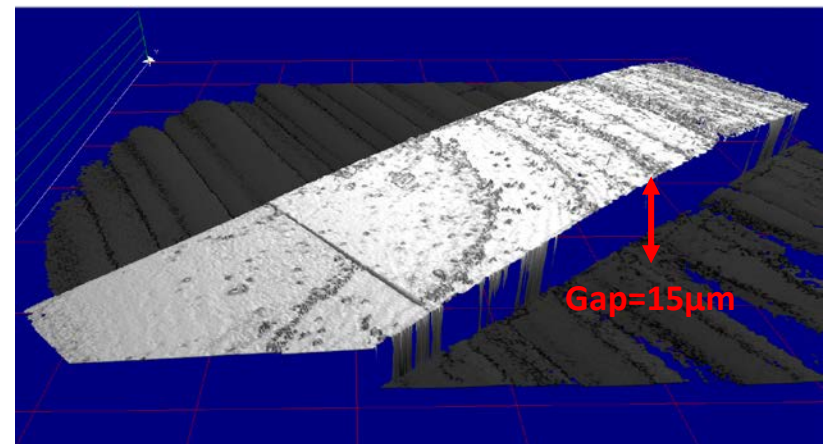


Setup for valve deflection measurement

Flat valve at room temperature (2000 μm)

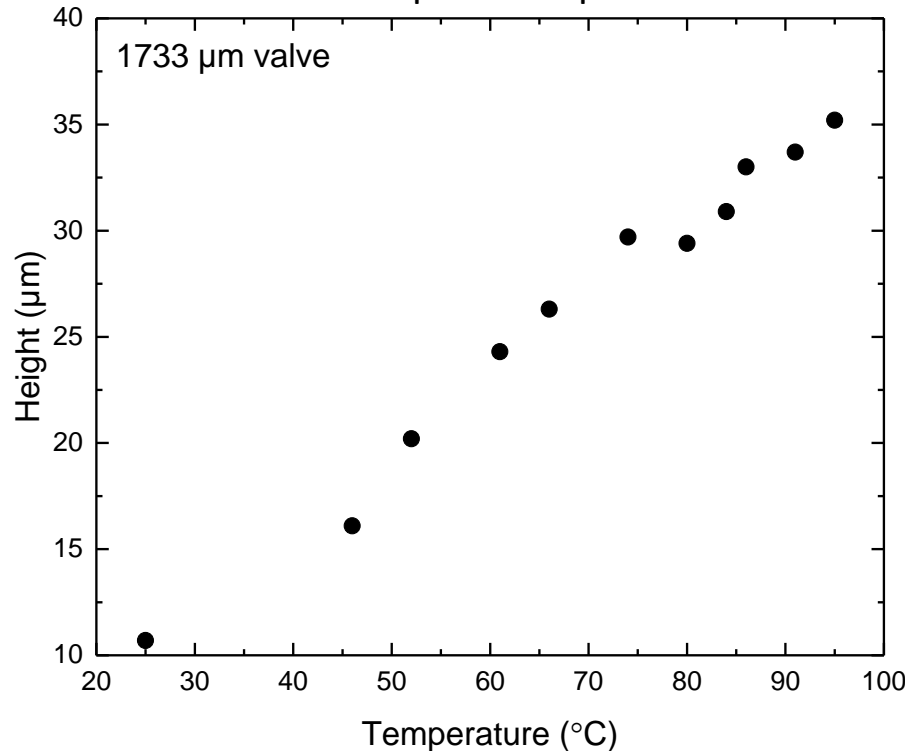


Curved valve at 80°C



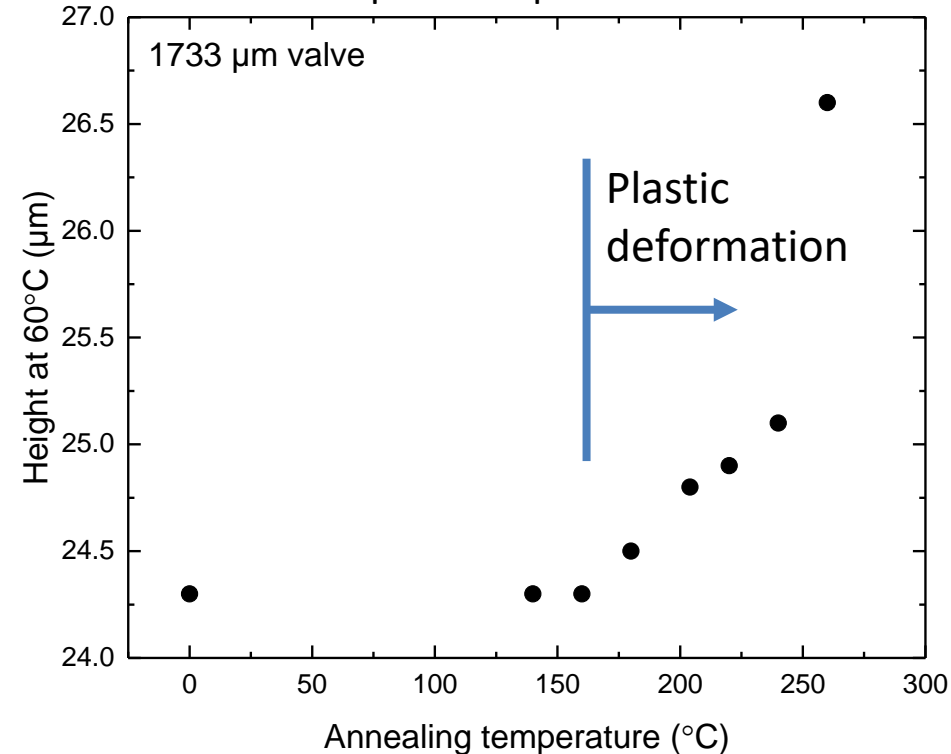
Microvalve deflection measurements

Top height of the 1733 μm valve in regard of the hot plate temperature



Gap Over 1000 % the initial value

Top valve at 60 $^{\circ}\text{C}$ after being exposed to a peak temperature



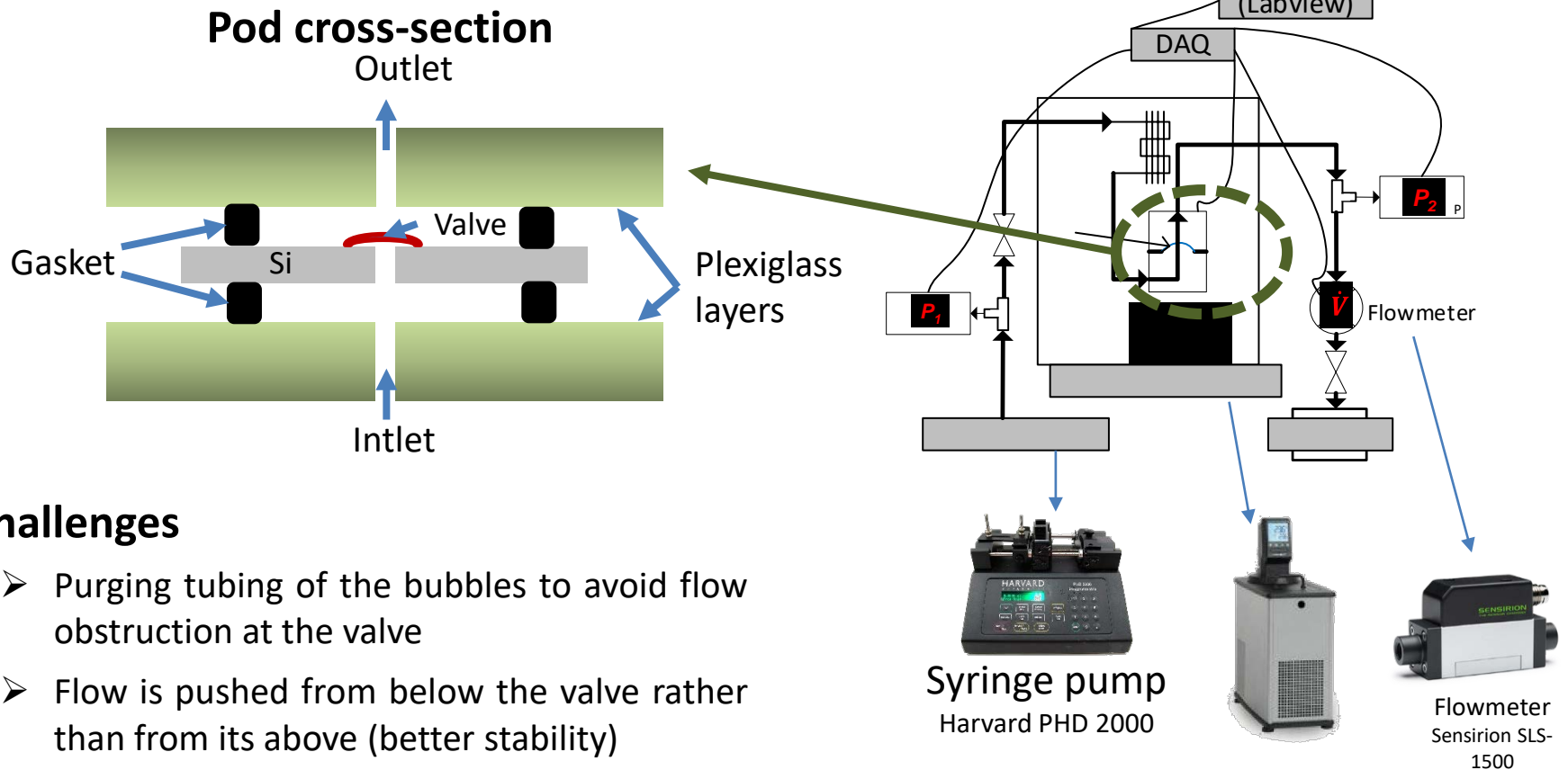
Safe operating range $\leq 160^{\circ}\text{C}$

Experimental characterization

Objectives and methods

- To evaluate the thermofluidic response of the microvalves
- To measure the pressure drop across the microvalve, varying:
 - Masse flow rate
 - Temperature

Thermofluidic test bench for microvalves



Challenges

- Purging tubing of the bubbles to avoid flow obstruction at the valve
- Flow is pushed from below the valve rather than from its above (better stability)

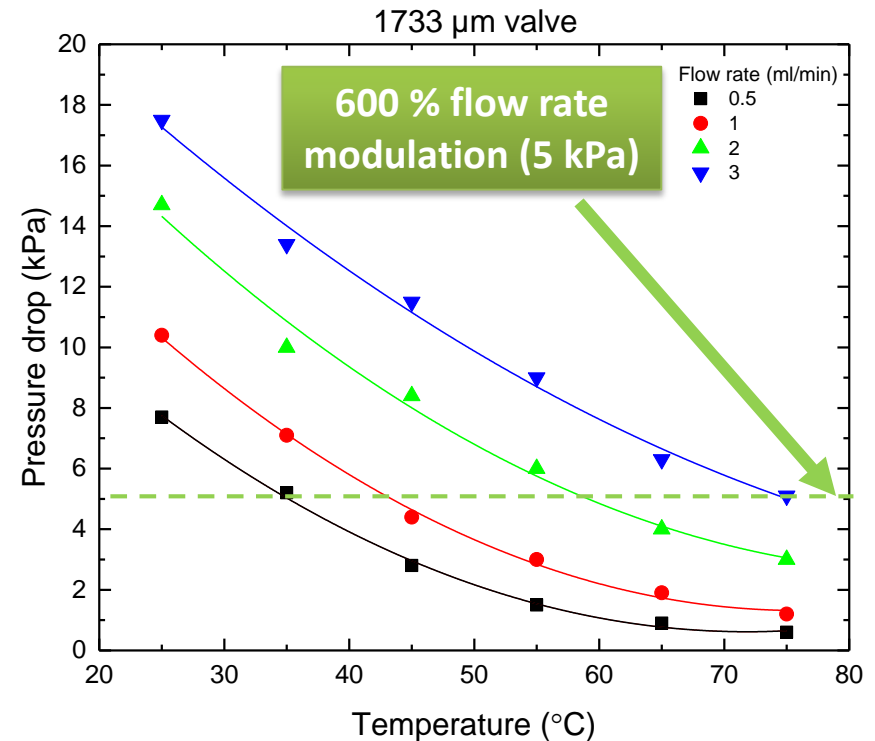
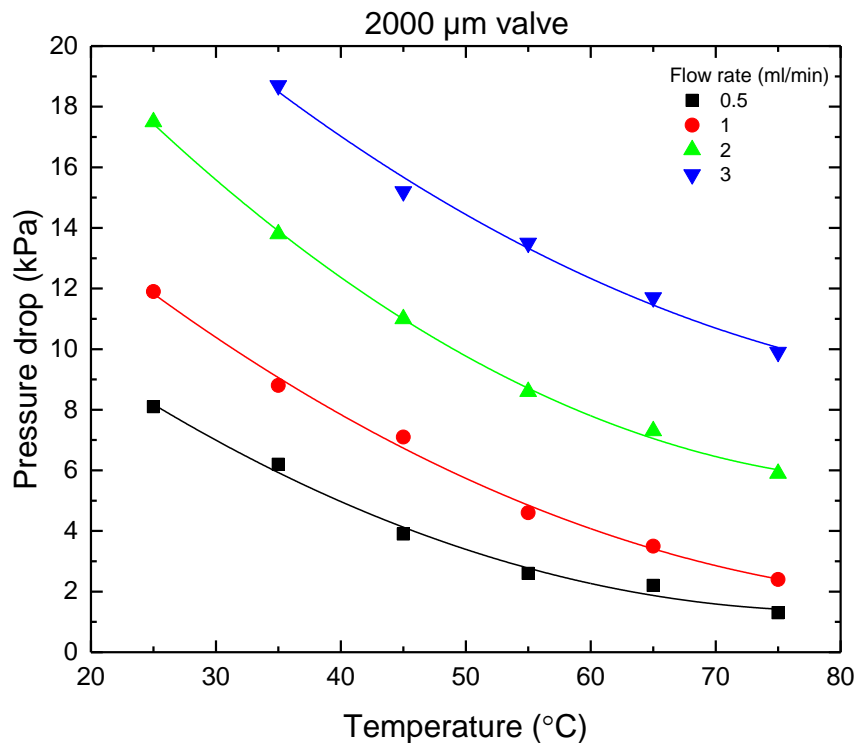
Experimental characterization

Fluidic performances

- Pressure drop across the canalisation (without valve) is 0.3 kPa at 3 ml/min
- Measurement errors
 - Pressure drop = 0.54%
 - Flow rate = $\pm 10\%$
 - Temperature = $\pm 2.2\text{ }^{\circ}\text{C}$

Thermoregulation is demonstrated

Pressure drop correlation to the temperature and the flow rate



Conclusion

- Microvalves made of silver have been successfully fabricated by MEMS fabrication methods.
 - First demonstration of temperature-driven self-adaptive microvalves in liquid
- Significant deflection was observed. The opening height goes from 2 (25°C) to 25 μm (95°C). This represents over 10 X the height of the initial opening
- Operating range up to 160 °C
- It is possible to control the flow rate from below 0.5 ml/min to 3.0 ml/min for a temperature range of 25 to 75 °C and an operating pressure drop of 5 kPa
- It opens the way of a better heat management in an ever more complex chip heterogeneity:
 - inherent temperature-driven passive control
 - zero power consumption adaptation
 - no added complexity for large cooling matrix

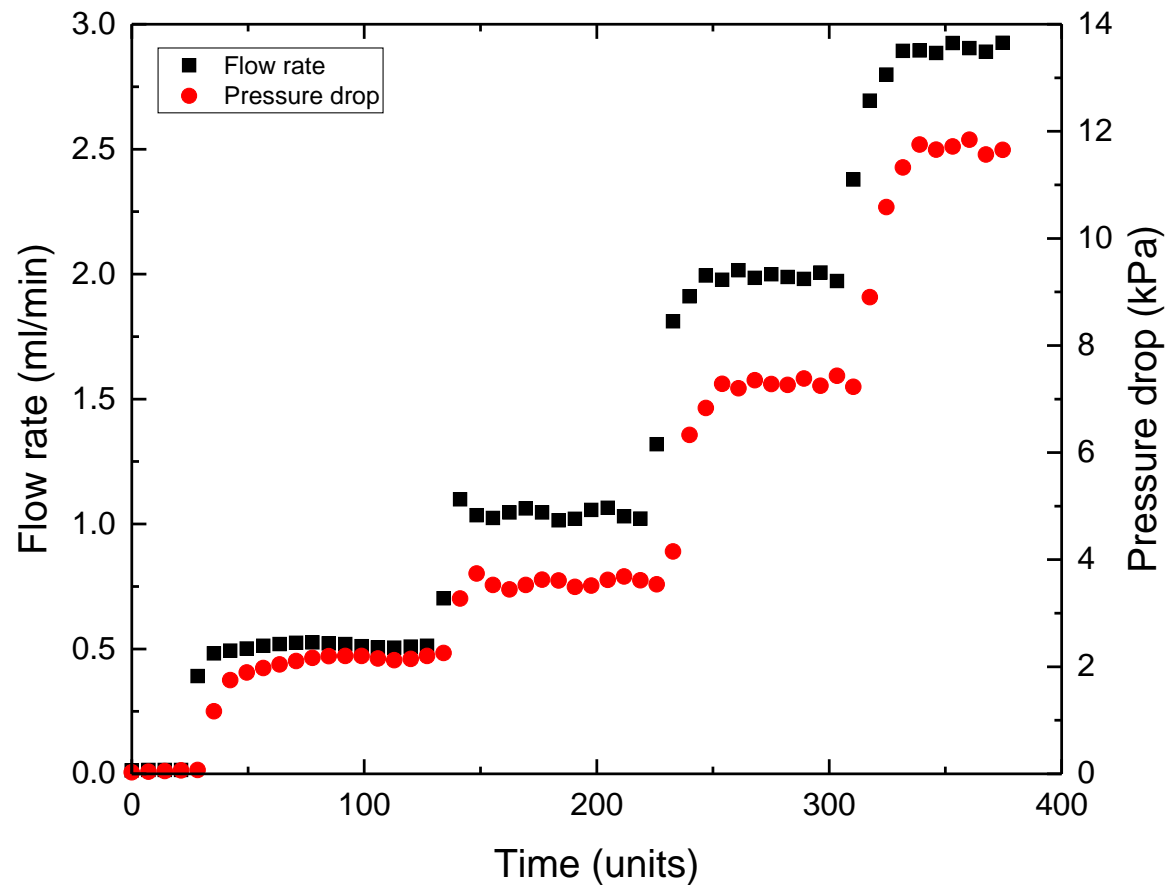
Acknowledgment

- European commission H2020 program
- Ministère économie, science et innovation du Québec

Fluidic characterization procedure

1. To make sure that the valve and the flow stream are at a specific temperature
2. To fix a flow rate
3. To measure the pressure drop

- ✓ Temperature range: 25 to 75°C
- ✓ Flow rate range: 0.5 to 3 ml/min

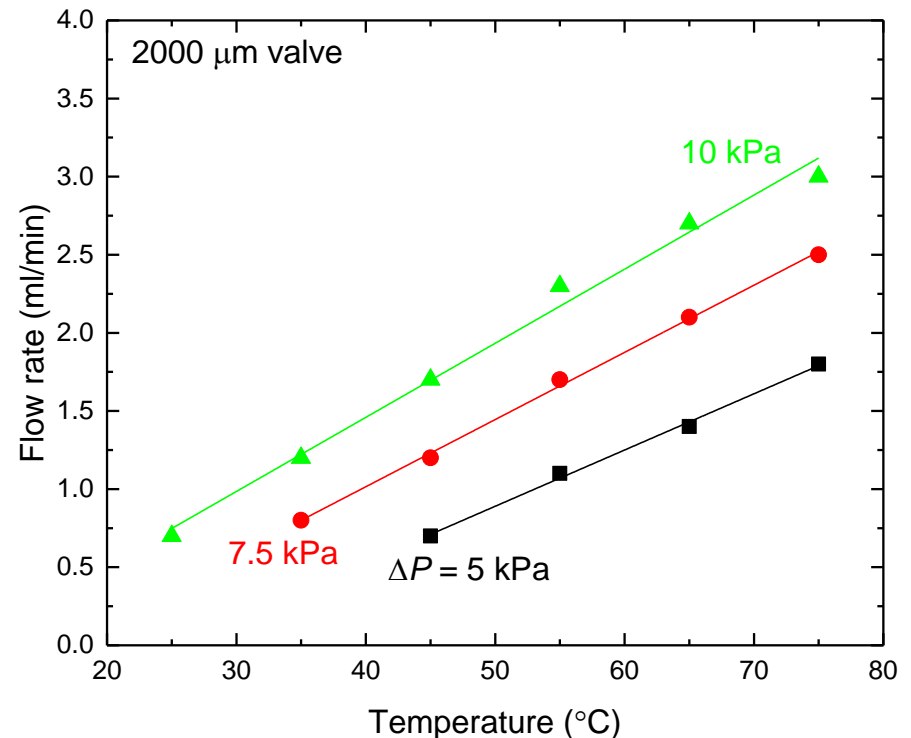
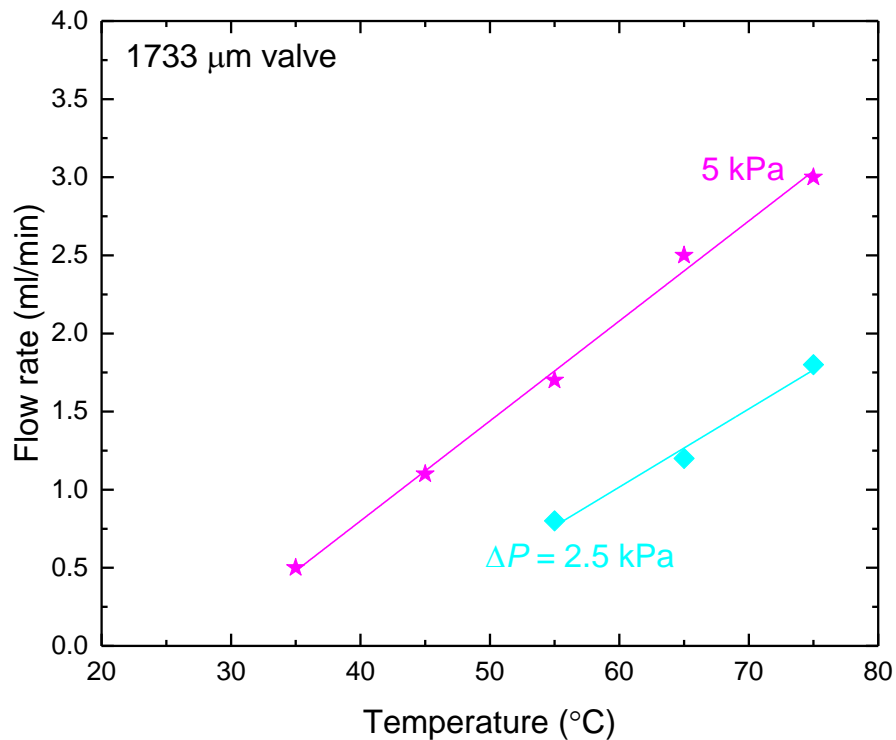


Fluidic measurements of the 2000 μm valve at 65 °C

Experimental characterization

Fluidic performances

- Interpolated flow rate in function of the temperature from the data
- Fixing ΔP through a valve and varying flow rate in function of temperature
- ✓ A wide range of flow rate in function of the temperature (0.5 to 3 ml/min for 25 to 75°C)
- ✓ The 1733 μm long valve has a steeper slope than the 2000 μm one
- ✓ Sensitivity = 0.0625 ml/°C



Interpolation of the flow rate in function of the temperature for different pressure drop in 2000 μm and 1733 μm long valves